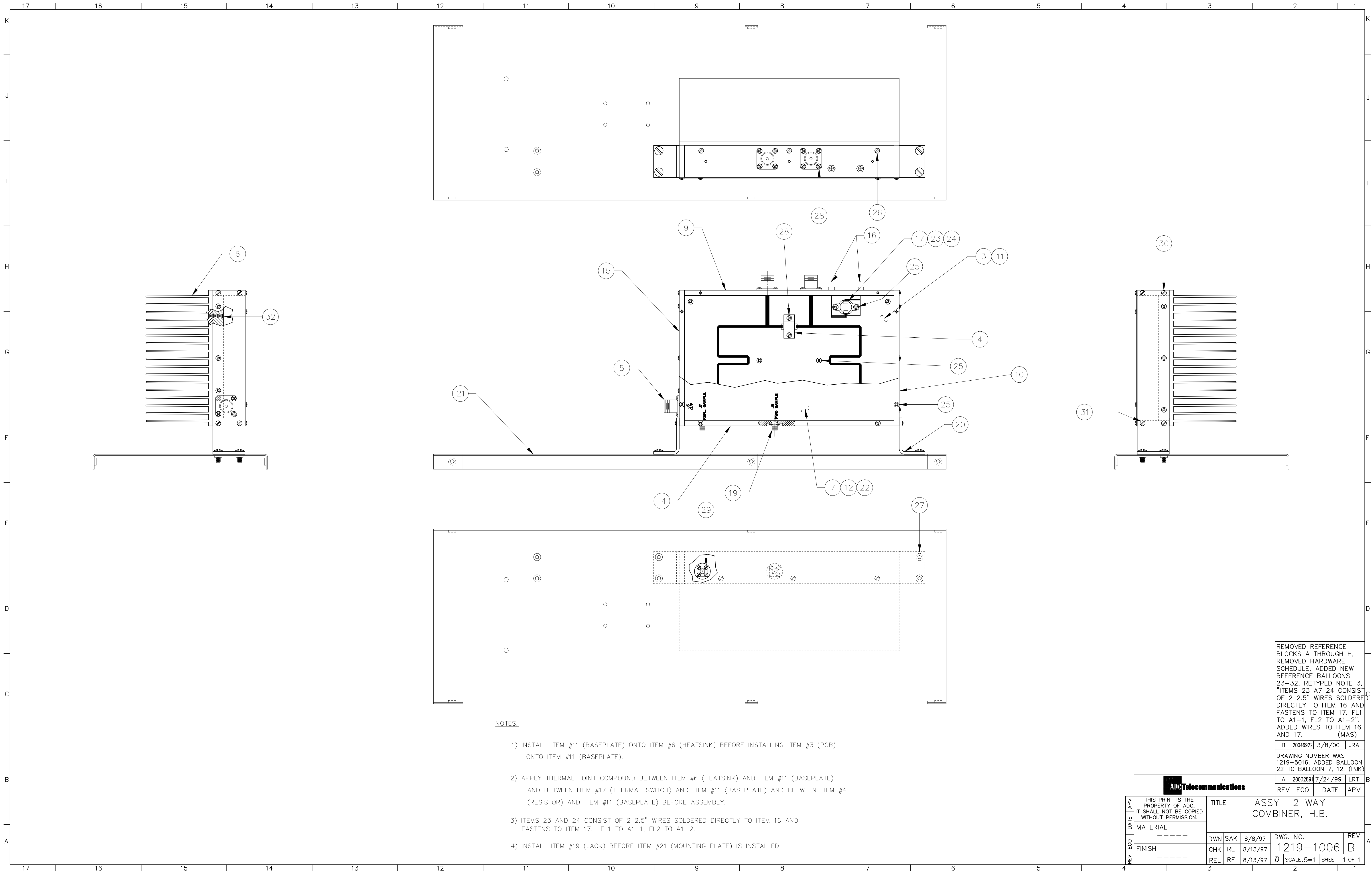




NOTES:

- 1) INSTALL ITEM #11 (BASEPLATE) ONTO ITEM #6 (HEATSINK) BEFORE INSTALLING ITEM #3 (PCB) ONTO ITEM #11 (BASEPLATE).
- 2) APPLY THERMAL JOINT COMPOUND BETWEEN ITEM #6 (HEATSINK) AND ITEM #11 (BASEPLATE) AND BETWEEN ITEM #17 (THERMAL SWITCH) AND ITEM #11 (BASEPLATE) AND BETWEEN ITEM #4 (RESISTOR) AND ITEM #11 (BASEPLATE) BEFORE ASSEMBLY.
- 3) ITEMS 23 AND 24 CONSIST OF 2 2.5" WIRES SOLDERED DIRECTLY TO ITEM 16 AND FASTENS TO ITEM 17. FL1 TO A1-1, FL2 TO A1-2.
- 4) INSTALL ITEM #19 (JACK) BEFORE ITEM #21 (MOUNTING PLATE) IS INSTALLED.

REMOVED REFERENCE BLOCKS A THROUGH H, REMOVED HARDWARE SCHEDULE, ADDED NEW REFERENCE BALLOONS 23-32, RETYPED NOTE 3, "ITEMS 23 A7 24 CONSIST OF 2 2.5" WIRES SOLDERED DIRECTLY TO ITEM 16 AND FASTENS TO ITEM 17. FL1 TO A1-1, FL2 TO A1-2". ADDED WIRES TO ITEM 16 AND 17. (MAS)

B	20046922	3/8/00	JRA
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DRAWING NUMBER WAS 1219-5016. ADDED BALLOON 22 TO BALLOON 7, 12. (PJK)

A	20032891	7/24/99	LRT
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REV	ECO	DATE	APV
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				REV		ECO		DATE		APV					
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MATERIAL															

FINISH				DWN		SAK		8/8/97		DWG. NO.		REV			
				CHK		RE		8/13/97		1219-1006		B			
-----				REL		RE		8/13/97		D		SCALE, 5=1		SHEET 1 OF 1	